

Vishay Siliconix

N-Channel 100-V (D-S) MOSFET

CHARACTERISTICS

- N-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS

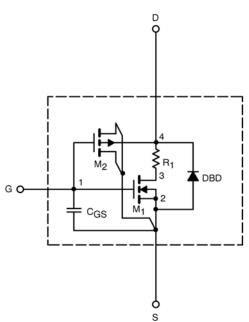
- Apply for both Linear and Switching Application
- Accurate over the –55 to 125°C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

DESCRIPTION

The attached spice model describes the typical electrical characteristics of the n-channel vertical DMOS. The subcircuit model is extracted and optimized over the -55 to 125° C temperature ranges under the pulsed 0-V to 10-V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

SUBCIRCUIT MODEL SCHEMATIC

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched C_{gd} model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.



This document is intended as a SPICE modeling guideline and does not constitute a commercial product data sheet. Designers should refer to the appropriate data sheet of the same number for guaranteed specification limits.



SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED)				
Parameter	Symbol	Test Condition	Typical	Unit
Static	· · ·			
Gate Threshold Voltage	V _{GS(th)}	V_{DS} = V_{GS} , I_D = 250 μ A	2.81	V
On-State Drain Current ^a	I _{D(on)}	$V_{\text{DS}}~\geq 5$ V, V_{GS} = 10 V	177	А
Drain-Source On-State Resistance ^a	r _{DS(on)}	V_{GS} = 10 V, I _D = 6.9 A	0.028	Ω
		V_{GS} = 6 V, I_{D} = 6.4 A	0.029	
Forward Transconductance ^a	g _{fs}	V_{DS} = 15 V, I_{D} = 6.9 A	30	S
Forward Voltage ^a	V _{SD}	$I_{\rm S}$ = 3.1 A, $V_{\rm GS}$ = 0 V	0.74	V
Dynamic ^b			-	
Total Gate Charge	Qg	V_{DS} = 50 V, V_{GS} = 10 V, I_{D} = 6.9 A	27	nC
Gate-Source Charge	Q _{gs}		7.6	
Gate-Drain Charge	Q _{gd}		5.4	
Turn-On Delay Time	t _{d(on)}	$\label{eq:V_DD} \begin{array}{l} V_{DD} \mbox{=} 505 \mbox{ V, } \mbox{R}_{L} \mbox{=} 50 \ \Omega \\ \mbox{I}_{D} \cong \mbox{ 1 A, } \mbox{V}_{GEN} \mbox{=} 10 \mbox{ V, } \mbox{R}_{G} \mbox{=} 6 \ \Omega \end{array}$	13	ns
Rise Time	tr		17	
Turn-Off Delay Time	t _{d(off)}		31	
Fall Time	t _f		55	
Source-Drain Reverse Recover Time	t _{rr}	IF = 3.1 A, di/dt – 100 A/µs	53	

Notes

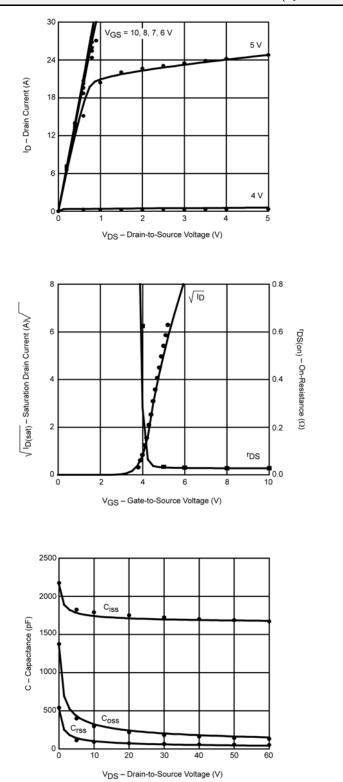
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2%. b. Guaranteed by design, not subject to production testing.



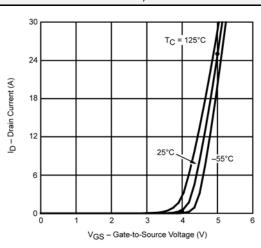
SPICE Device Model Si4484EY

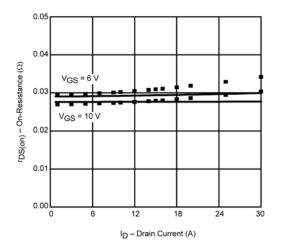
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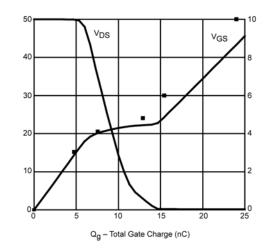
COMPARISON OF MODEL WITH MEASURED DATA (TJ=25°C UNLESS OTHERWISE NOTED)



Note: Dots and squares represent measured data.









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